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P1 98.2

MOS FIELD EFFECT POWER TRANSISTOR

2SJ303

SWITCHING

P-CHANNEL MOS FET

INDUSTRIAL USE

DESCRIPTION

The 2SJ303 is P-channel MOS Field Effect Transistor designed for solenoid, motor and lamp driver.

FEATURES

- Low On-state Resistance.
 $R_{DS(on)} \leq 0.1 \Omega$ ($V_{GS} = -10 \text{ V}$, $I_D = -7 \text{ A}$)
 $R_{DS(on)} \leq 0.24 \Omega$ ($V_{GS} = -4 \text{ V}$, $I_D = -6 \text{ A}$)
- Low C_{iss} $C_{iss} = 1200 \text{ pF TYP.}$
- Built-in G-S Gate Protection Diode
- Isolated TO-220 Package

QUALITY GRADE

Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

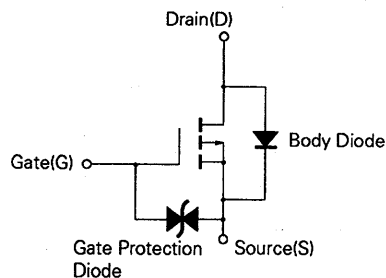
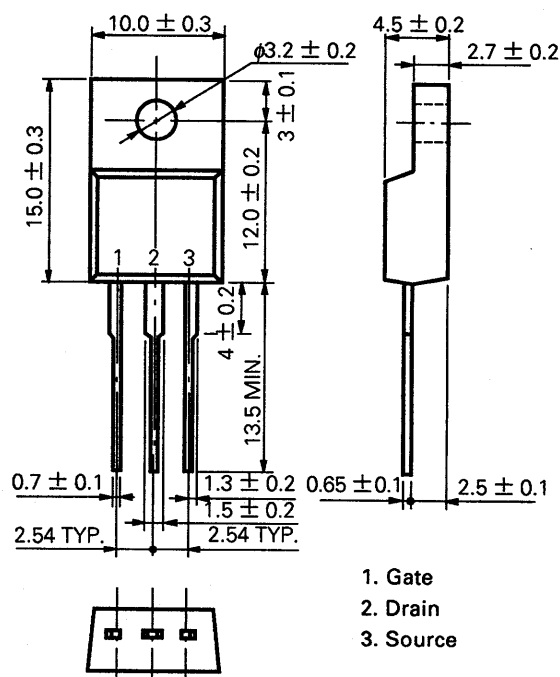
ABSOLUTE MAXIMUM RATINGS ($T_a = 25^\circ\text{C}$)

Drain to Source Voltage	V_{DSS}	-60	V
Gate to Source Voltage	V_{GSS}	-20, +10	V
Drain Current (DC)	$I_{D(DC)}$	± 14	A
Drain Current (pulse)	$I_{D(pulse)*}$	± 56	A
Total Power Dissipation ($T_c = 25^\circ\text{C}$)	P_{T1}	35	W
Total Power Dissipation ($T_a = 25^\circ\text{C}$)	P_{T2}	2.0	W
Channel Temperature	T_{ch}	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

* $PW \leq 10 \mu\text{s}$, Duty Cycle $\leq 1\%$

PACKAGE DIMENSIONS

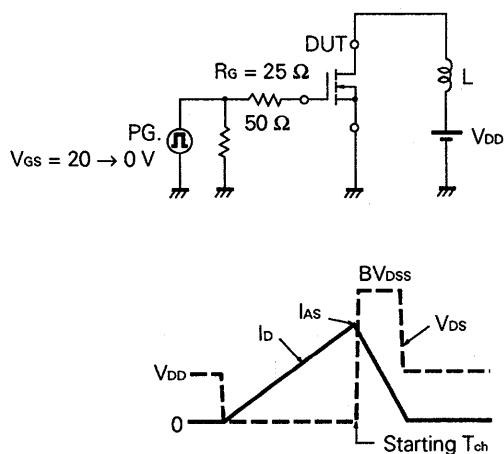
in millimeters



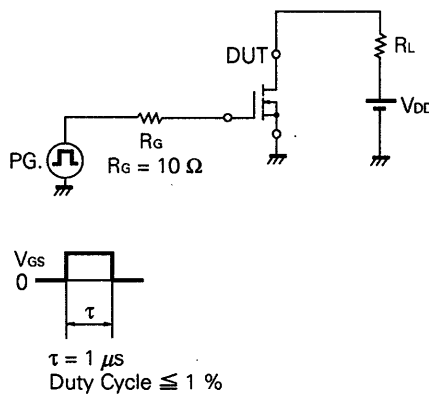
ELECTRICAL CHARACTERISTICS ($T_a = 25^\circ\text{C}$)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-state Resistance	$R_{DS(on)}$		75	100	$m\Omega$	$V_{GS} = -10\text{ V}$, $I_D = -7\text{ A}$
Drain to Source On-state Resistance	$R_{DS(on)}$		130	240	$m\Omega$	$V_{GS} = -4.0\text{ V}$, $I_D = -6\text{ A}$
Gate to Source Cutoff Voltage	$V_{GS(off)}$	-1.0		-2.0	V	$V_{DS} = -10\text{ V}$, $I_D = -1\text{ mA}$
Forward Transfer Admittance	$ y_{fs} $	5.0			S	$V_{DS} = -10\text{ V}$, $I_D = -7\text{ A}$
Drain Leakage Current	I_{DSS}			-10	μA	$V_{DS} = -60\text{ V}$, $V_{GS} = 0$
Gate to Source Leakage Current	I_{GSS}			± 10	μA	$V_{GS} = \pm 16\text{ V}$, $V_{DS} = 0$
Input Capacitance	C_{iss}		1200		pF	$V_{DS} = -10\text{ V}$ $V_{GS} = 0$ $f = 1\text{ MHz}$
Output Capacitance	C_{oss}		670		pF	
Reverse Transfer Capacitance	C_{rss}		290		pF	
Turn-On Delay Time	$t_{d(on)}$		30		ns	$V_{GS(on)} = -10\text{ V}$ $V_{DD} = -30\text{ V}$ $I_D = -7\text{ A}$, $R_G = 10\ \Omega$ $R_L = 4.3\ \Omega$
Rise Time	t_r		110		ns	
Turn-Off Delay Time	$t_{d(off)}$		160		ns	
Fall Time	t_f		120		ns	
Total Gate Charge	Q_G		42		nC	$V_{GS} = -10\text{ V}$ $I_D = -16\text{ A}$ $V_{DD} = -48\text{ V}$
Gate to Source Charge	Q_{GS}		3		nC	
Gate to Drain Charge	Q_{GD}		17		nC	
Diode Forward Voltage	V_{SD}		1.0		V	$I_F = -14\text{ A}$, $V_{GS} = 0$
Reverse Recovery Time	t_{rr}		120		ns	$I_F = -14\text{ A}$, $V_{GS} = 0$ $di/dt = 50\text{ A}/\mu\text{s}$
Reverse Recovery Charge	Q_{rr}		230		nC	

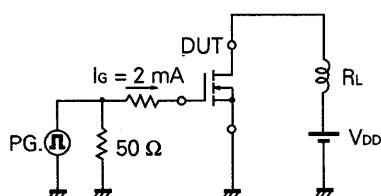
Test Circuit 1 : Avalanche Capability



Test Circuit 2 : Switching Time

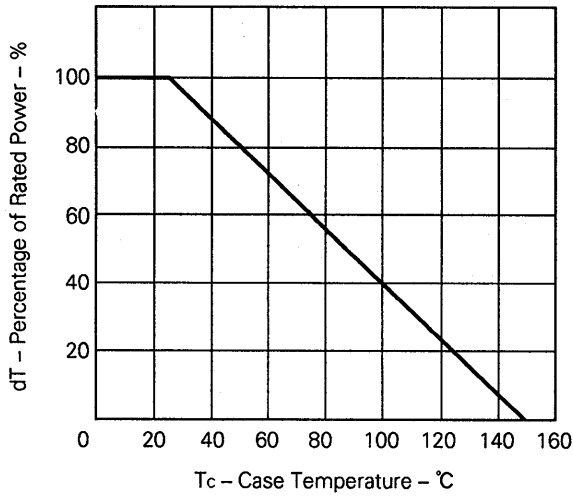


Test Circuit 3 : Gate Charge

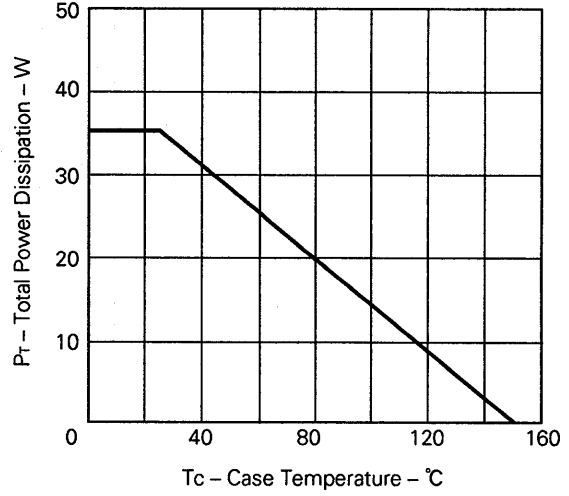


TYPICAL CHARACTERISTICS ($T_a = 25^\circ\text{C}$)

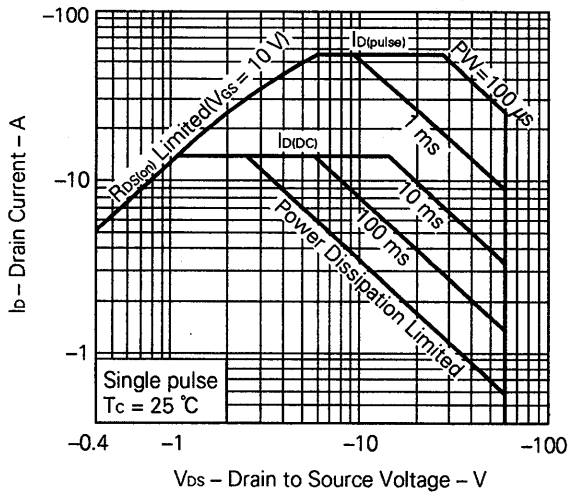
DERATING FACTOR OF FORWARD BIAS
SAFE OPERATING AREA



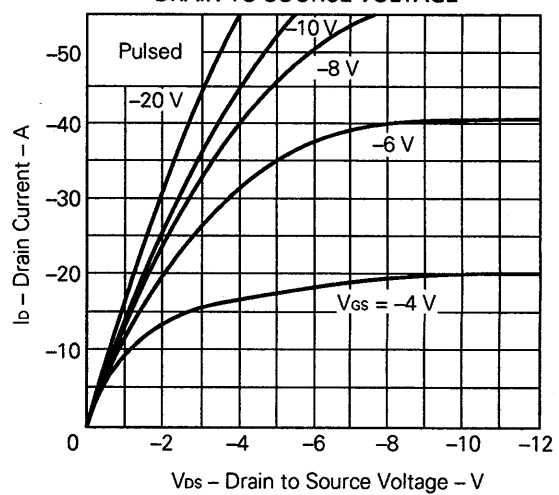
TOTAL POWER DISSIPATION vs.
CASE TEMPERATURE



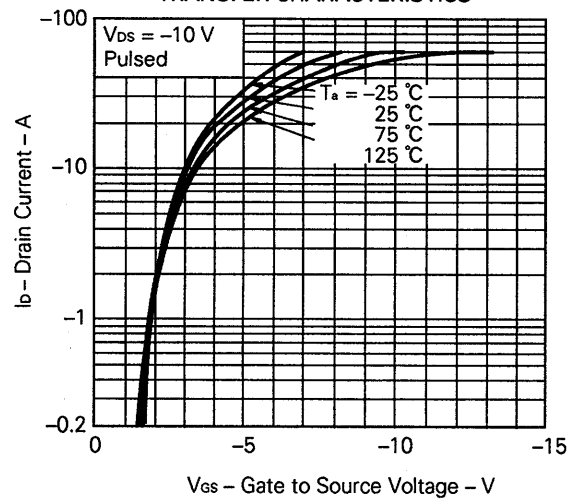
FORWARD BIAS SAFE OPERATING AREA

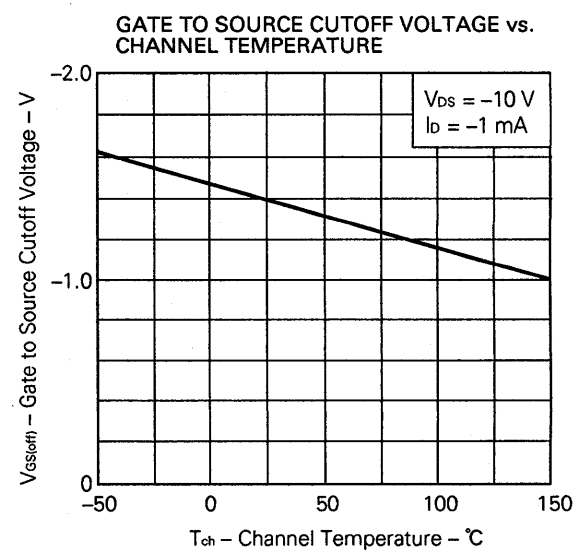
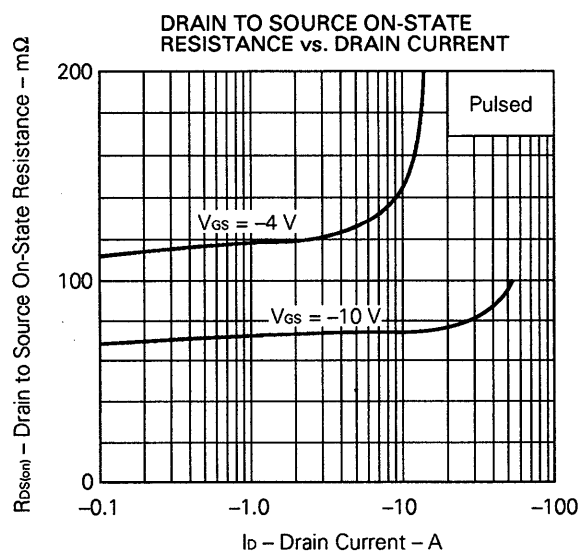
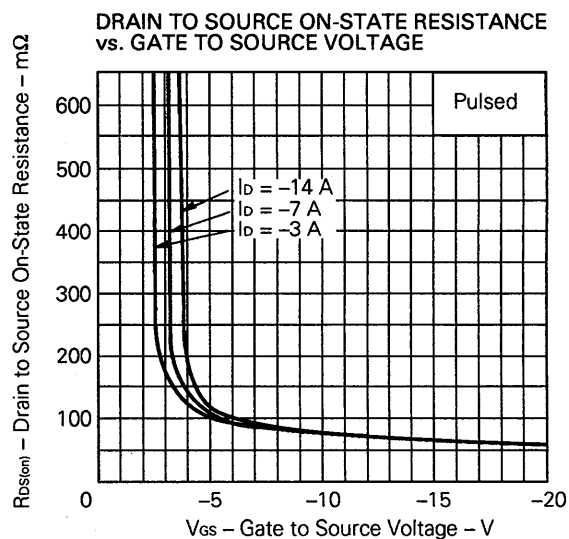
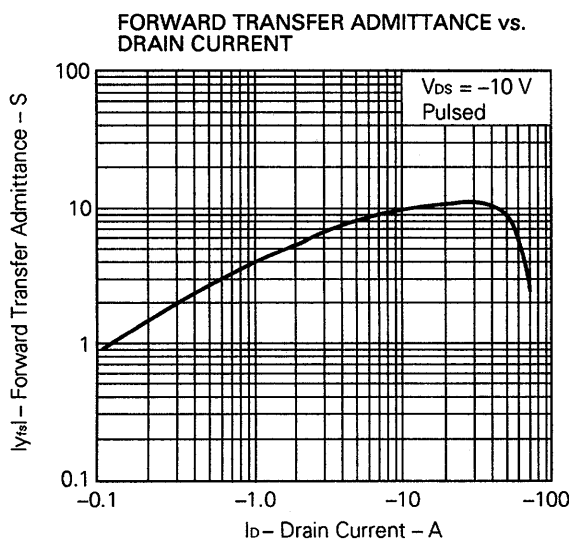
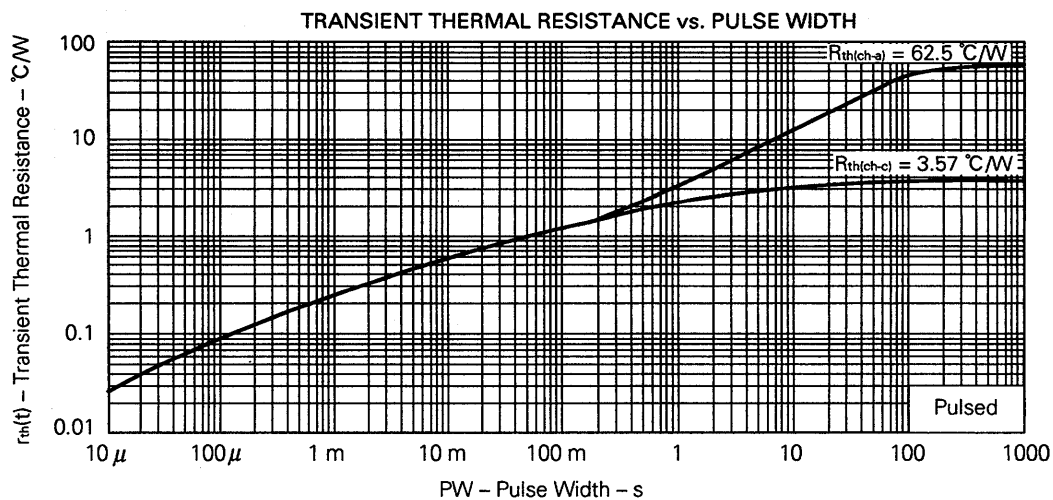


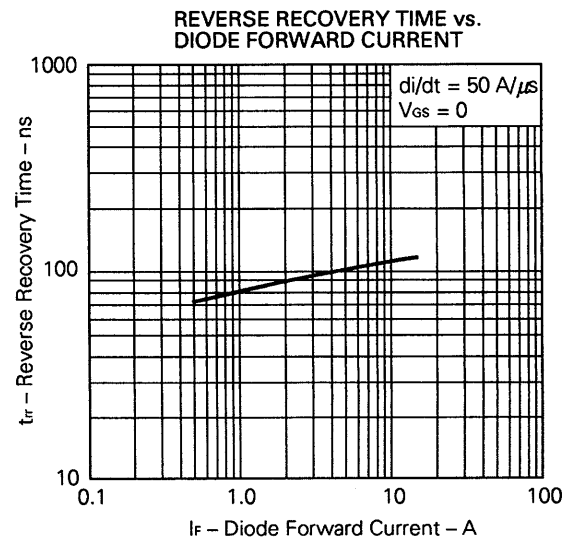
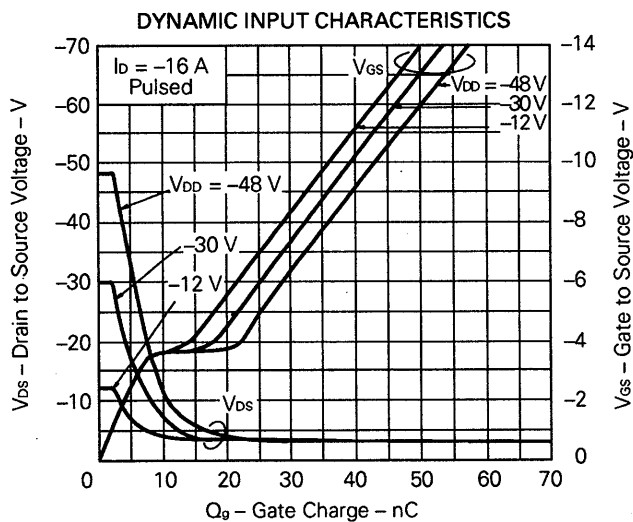
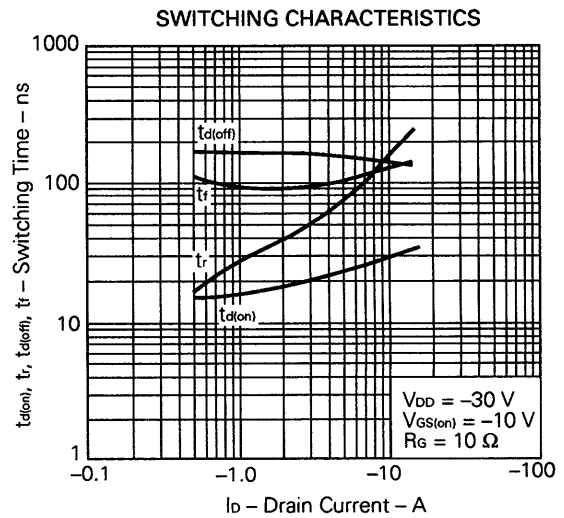
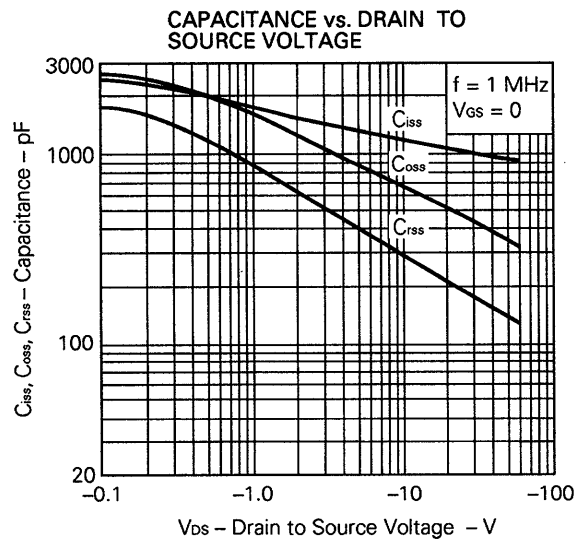
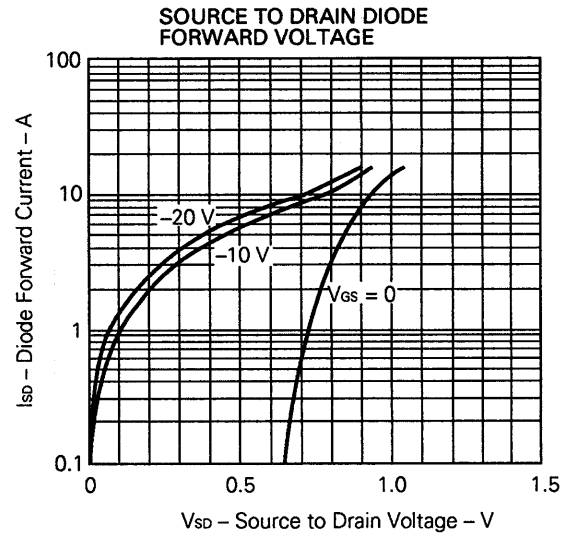
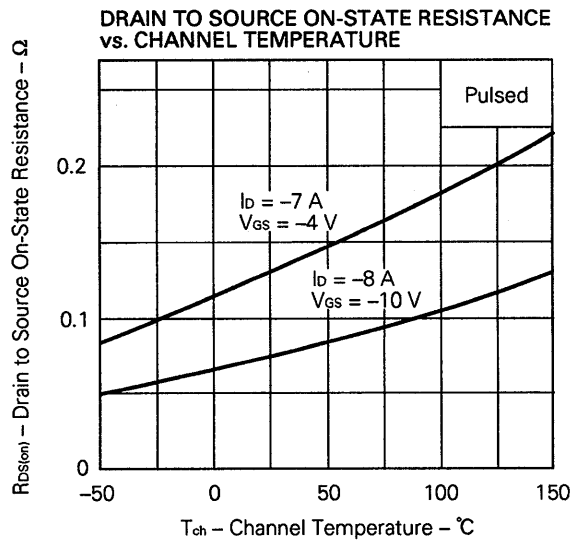
DRAIN CURRENT vs.
DRAIN TO SOURCE VOLTAGE

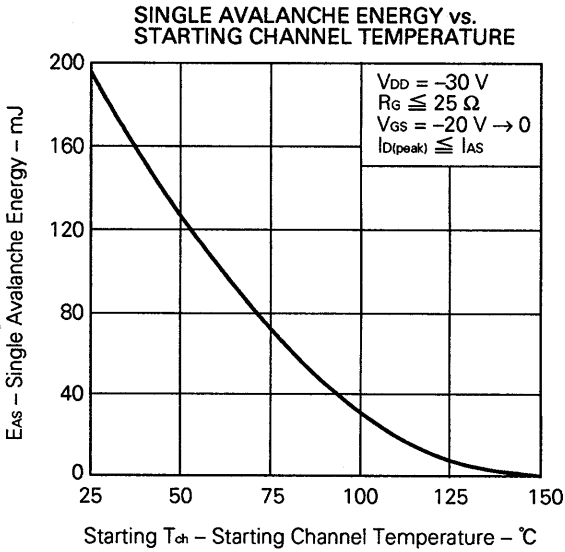
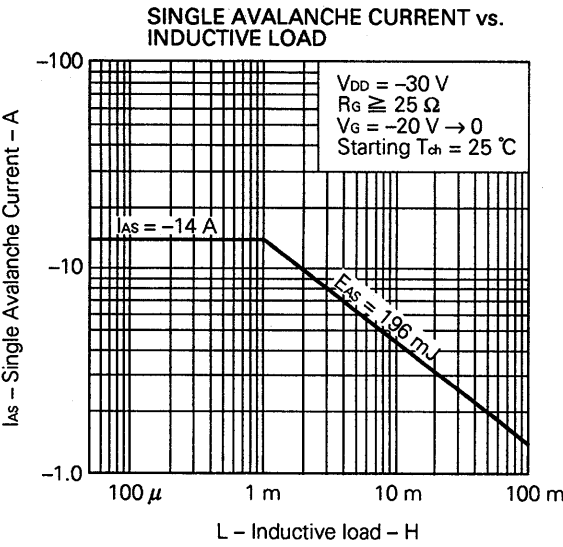


TRANSFER CHARACTERISTICS









Reference

Application note name	No.
Safe operating area of Power MOS FET.	TEA-1034
Application circuit using Power MOS FET.	TEA-1035
Quality control of NEC semiconductors devices.	TEI-1202
Quality control guide of semiconductors devices.	MEI-1202
Assembly manual of semiconductors devices.	IEI-1207

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